

# NZF220DFT1G, SNZF220DFT1G

## EMI Filter with ESD Protection

### Features

- 2 EMI/RFI Bi-directional “Pi” Low-Pass Filters
- ESD Protection Meets IEC61000-4-2
- Diode Capacitance: 7 – 10 pF
- Zener/Resistor Line Capacitance:  $22 \pm 20\%$  pF
- Low Zener Diode Leakage: 1  $\mu$ A Maximum
- Zener Breakdown Voltage; 6 – 8 V
- AEC-Q101 Qualified and PPAP Capable – SNZF220DFT1G
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These are Pb-Free Devices

### Benefits

- Designed to suppress EMI/RFI Noise in Systems Subjected to Electromagnetic Interference
- Nominal Cutoff Frequency of 220 MHz (per Figure 2)
- Small Package Size Minimizes Parasitic Inductance, Thus a More “Ideal” Low Pass Filtering Response

### Typical Applications

- Cellular Phones
- Communication Systems
- Computers
- Portable Products with Input/Output Conductors

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Power Dissipation (Note 1) $8 \times 20 \mu$ s Pulse	$P_{PK}$	14	W
Maximum Junction Temperature	$T_J$	150	$^{\circ}$ C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

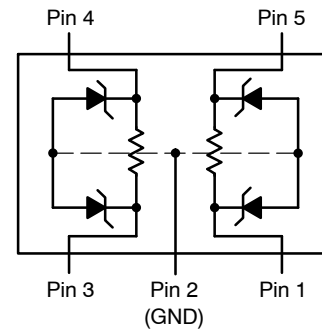
1. Between I/O Pins



**ON Semiconductor**<sup>®</sup>

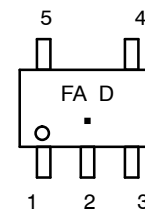
<http://onsemi.com>

### CIRCUIT DESCRIPTION



**SC-88A  
DF SUFFIX  
CASE 419A**

### MARKING DIAGRAM



FA = Specific Device Code  
D = Date Code  
▪ = Pb-Free Package

### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
NZF220DFT1G	SC-88A (Pb-Free)	3000 / Tape & Reel
SNZF220DFT1G	SC-88A (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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## ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Min	Typ	Max	Unit
$V_Z$	Zener Breakdown Voltage, @ $I_{ZT} = 1 \text{ mA}$	6.0	–	8.0	V
$I_r$	Zener Leakage Current, @ $V_R = 3 \text{ V}$	N/A	–	1.0	$\mu\text{A}$
$V_F$	Zener Forward Voltage, @ $I_F = 50 \text{ mA}$	N/A	–	1.5	V
Capacitance	Zener Internal Capacitance, @ 0 V Bias	7.0	–	10	pF
Capacitance	Zener/Resistor Array Line Capacitance	17.6	–	26.4	pF
Resistor	Resistance	90	–	110	$\Omega$
$F_C$ (Note 2)	Cutoff Frequency	–	220	–	MHz

2. 50  $\Omega$  Source and 50  $\Omega$  Lead Termination per Figure 2.

## Applications Information

### Suppressing Noise at the Source

- Filter all I/O signals leaving the noisy environment
- Locate I/O driver circuits close to the connector
- Use the longest rise/fall times possible for all digital signals

### Reducing Noise at the Receiver

- Filter all I/O signals entering the unit
- Locate the I/O filters as close as possible to the connector

### Minimizing Noise Coupling

- Use multilayer PCBs to minimize power and ground inductance
- Keep clock circuits away from the I/O connector
- Ground planes should be used whenever possible
- Minimize the loop area for all high speed signals
- Provide for adequate power decoupling

### ESD Protection

- Locate the suppression devices as close to the I/O connector as possible
- Minimize the PCB trace length to the suppression device
- Minimize the PCB trace length for the ground return for the suppression device

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## FREQUENCY RESPONSE SPECIFICATION

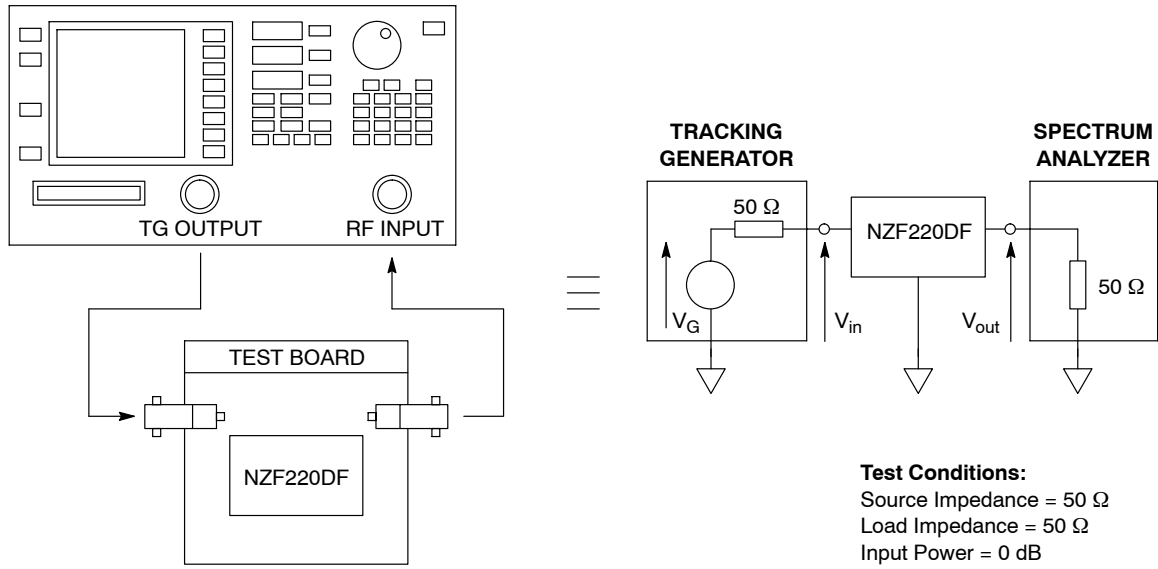


Figure 1. Measurement Conditions

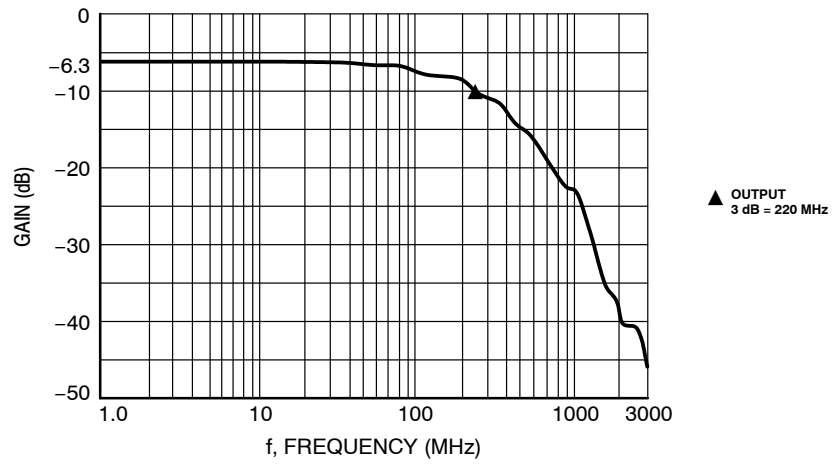


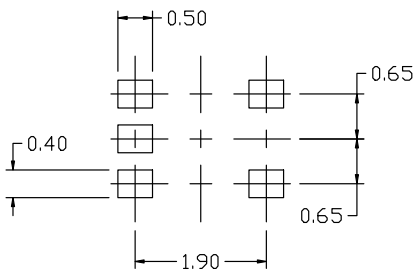
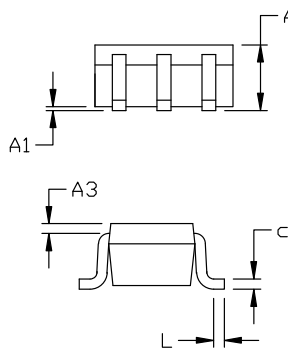
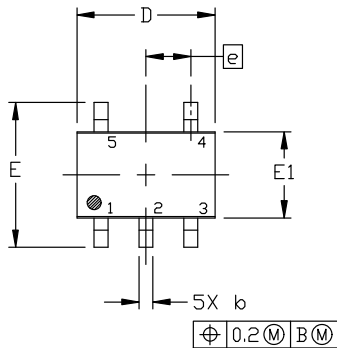
Figure 2. Typical EMI Filter Response  
 (50  $\Omega$  Source and 50  $\Omega$  Lead Termination)



SCALE 2:1

SC-88A (SC-70-5/SOT-353)  
CASE 419A-02  
ISSUE M

DATE 11 APR 2023



RECOMMENDED MOUNTING FOOTPRINT

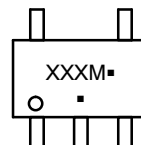
\* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERM/D.

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS
3. 419A-01 OBSOLETE. NEW STANDARD 419A-02
4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.80	0.95	1.10
A1	---	---	0.10
A3	0.20 REF		
b	0.10	0.20	0.30
c	0.10	---	0.25
D	1.80	2.00	2.20
E	2.00	2.10	2.20
E1	1.15	1.25	1.35
e	0.65 BSC		
L	0.10	0.15	0.30

GENERIC MARKING DIAGRAM\*



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

STYLE 1:

- PIN 1. BASE
- EMITTER
- BASE
- COLLECTOR
- COLLECTOR

STYLE 2:

- PIN 1. ANODE
- EMITTER
- BASE
- COLLECTOR
- CATHODE

STYLE 3:

- PIN 1. ANODE 1
- N/C
- ANODE 2
- CATHODE 2
- CATHODE 1

STYLE 4:

- PIN 1. SOURCE 1
- DRAIN 1/2
- SOURCE 1
- GATE 1
- GATE 2

STYLE 5:

- PIN 1. CATHODE
- COMMON ANODE
- CATHODE 2
- CATHODE 3
- CATHODE 4

STYLE 6:

- PIN 1. EMITTER 2
- BASE 2
- EMITTER 1
- COLLECTOR
- COLLECTOR 2/BASE 1

STYLE 7:

- PIN 1. BASE
- EMITTER
- BASE
- COLLECTOR
- COLLECTOR

STYLE 8:

- PIN 1. CATHODE
- COLLECTOR
- N/C
- BASE
- EMITTER

STYLE 9:

- PIN 1. ANODE
- CATHODE
- ANODE
- ANODE
- ANODE

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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